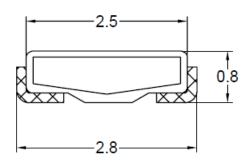
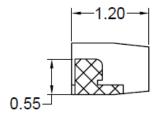
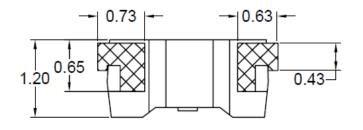


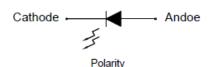
2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

PACKAGE OUTLINES

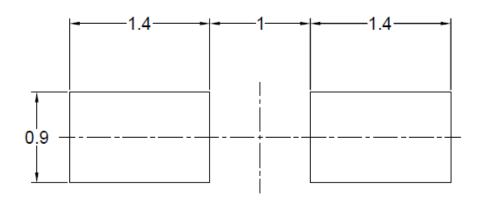








RECOMMENDED SOLDERING PAD DIMENSIONS



Part Number	Material	Lens Color		
Part Number	Material	Emitted Lens		
L233QBC-TR	InGaN	Blue	Water Clear	

Notes:

- 1. All dimension is in millimeter;
- 2. Tolerance ±0.1mm unless, angle ±0.5mm unless otherwise noted



2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

Parameter	Symbol	Value	Unit
Forward Current	I _F	30	mA
Peak Forward Current (Duty 1/11 @ 10Khz)	I _{FP}	100	mA
Reverse Current @ 5V	I _R	50	μΑ
Power Dissipation	P _D	108	mW
Electrostatic Discharge	ESD	500	V
Operating Temperature Range	T _{OPR}	-20~+80	ōС
Storage Temperature Range	T _{STG}	-30~+100	°С

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Luminous Intensity	I _V		200	260	1	mcd
Dominant Wavelength	λ_{D}		465		477	nm
Spectral Line Half-Width	Δλ	$I_F = 20 \text{mA}$		30		nm
Viewing Angle	20 ½			115		deg
Forward Voltage	V _F		2.8		3.6	V

^{1.} Forward voltage data did not include $\pm 0.1 V$ testing tolerance.

^{2.} Luminous intensity data did not include $\pm 15\%$ testing tolerance.



2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

LUMINOUS INTENSITY CLASSIFICATION

BIN CODE		Iv(mcd) at 20mA		
		Min.	Max.	
	S1	200	230	
S	S2	230	260	
3	S3	260	290	
	S4	290	320	

DOMINANT WAVELENGTH CLASSIFICATION

BIN CODE	λD(nm) at 20mA		
BIN CODE	Min.	Max.	
0D	465	468	
0C	468	471	
0B	471	474	
0A	474	477	

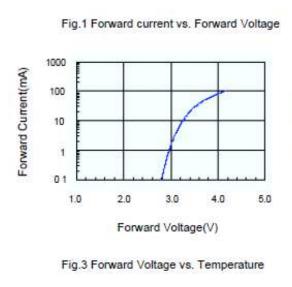
FORWARD VOLTAGE CLASSIFICATION

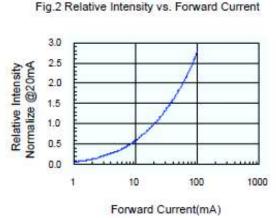
BIN CODE	Vf(v) a	Vf(v) at 20mA		
	Min.	Max.		
1	2.8	2.9		
2	2.9	3.0		
3	3.0	3.1		
4	3.1	3.2		
5	3.2	3.3		
6	3.3	3.4		
7	3.4	3.5		
8	3.5	3.6		



2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES





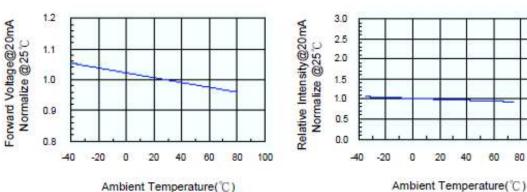
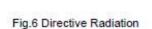


Fig.4 Relative Intensity vs. Temperature



20

80

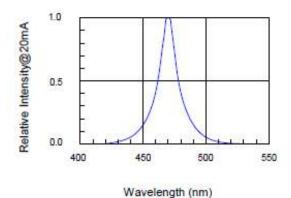
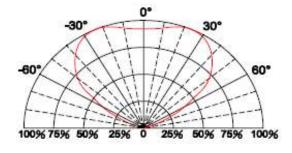


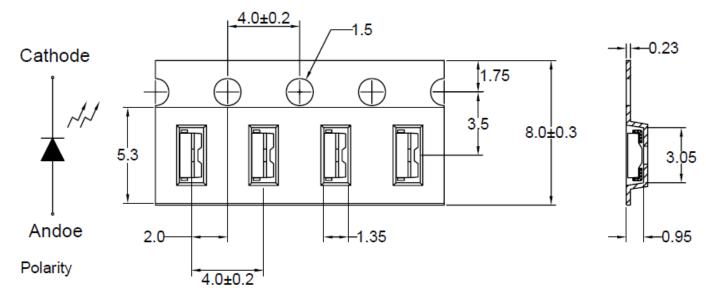
Fig.5 Relative Intensity vs. Wavelength





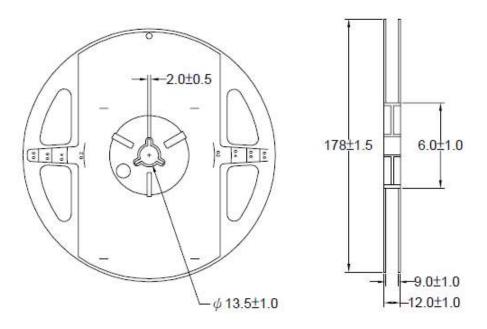
2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

CARRIER TAPE DIMENSION



Note: The tolerances unless mentioned are ±0.1mm, Angle ±0.5mm

REEL DIMENSIONS



Note: 8.0mm tape, 7: reel / 3000 devices per reel.



2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

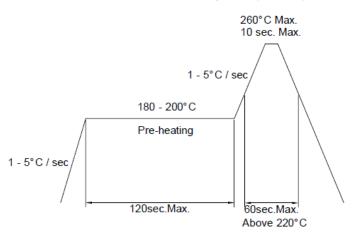
RECOMMENDED SOLDERING CONDITIONS

Soldering Iron:

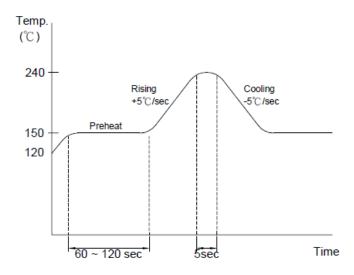
Basic spec is ≤ 5 seconds when 260°C.

Power dissipation of iron should be smaller than 25W,and temperature should be controllable. Surface temperature of the device should be under 280 ℃ for 3 seconds.

Reflow Temp/Time(Pb-free)



Reflow Temp/Time(Lead solder)



Notes:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.

6



2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

PRECAUTIONS FOR USE

Storage Time:

- 1. The operation of temperatures and RH are: 5°C~35°C, RH60%.
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year (from production date).
- 3. If opened more than one week in an atmosphere 5°C~35°C, RH60%, they should be treated at 60°C±5°C for 15hrs.

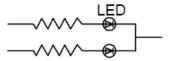
Drive Method:

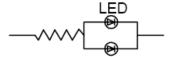
LED is a current operated device, and therefore, require some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in a series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A

Circuit model B





- (A) Recommended circuit.
- (B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LEDs. All devices and machinery must be properly grounded.



2.8 x 0.8 x 1.2 Right Angle BLUE SMD, Tape and Reel

RELIABILITY TEST:

(1) Test items and results

Classification	Test Item	Test Conditions	Sample Size
	Operating Life Test	1. Ta=under room temperature as per data sheet maximum rating 2. If=20mA 3. t=1000 hrs	22
Endurance Test	High Temperature Storage Test	1. Ta=105°C±5°C 2. t=500 hrs	22
nduran	Low Temperature Storage Test	1. Ta=40°C±5°C 2. t=1000 hrs	22
Ш	High Humidity	1. IR-Reflow in-board, 2 times 2. Ta=85°C±5°C 3. RH=90%~95% 4. t=500hrs±2hrs	22
al Test	Thermal Shock Test	1. IR-Reflow in-board, 2 times 2. Ta=105°C±5°C & -40°C±5°C (30min) (30min) 3. Total 100 cycles	22
Environmental Test	Reflow Soldering Test	1. Tsol=260°C±5°C 2. Dwell time = 10 max	22
	Temperature Cycling	1. 105°C ~ 25°C ~ -40°C 30 mins 15 mins 30 mins 2. 100 cycles	22

(2) Criteria for judging the damage

Item	Symbol	Test Conditions	Criteria for Judgement		
пеш	Symbol	rest Conditions	Min.	Max.	
Forward Voltage	V_{f}	I _f =20mA		U.S.L. x 1.2	
Reverse Current	l _r	V _r =5V		U.S.L. x 2.0	
Luminous Intensity	I _v	I _f =20mA	L.S.L. x 0.5		

Note:

1. U.S.L.: Upper Standard Level. 2. L.S.L: Lower Standard Level